TOSHIBA Field Effect Transistor Silicon N Channel MOS Type  $(\pi\text{-MOSII}^{5})$ 

# 2SK1489

#### **Chopper Regulator Applications**

Unit: mm

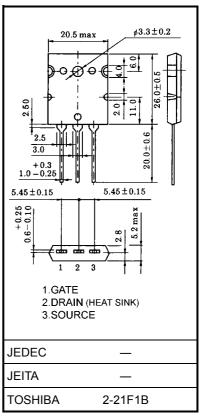
 $\begin{array}{ll} \bullet & Low\ drain-source\ ON\ resistance & :\ R_{DS}\ (ON) = 0.8\ \Omega\ (typ.) \\ \bullet & High\ forward\ transfer\ admittance & :\ |\ Y_{fs}\ | = 6.0\ S\ (typ.) \\ \bullet & Low\ leakage\ current & :\ I_{DSS} = 300\ \mu A\ (max)\ (V_{DS} = 800\ V) \\ \bullet & Enhancement-mode & :\ V_{th} = 1.5 \\ \sim 3.5\ V\ (V_{DS} = 10\ V,\ I_{D} = 1\ mA) \end{array}$ 

#### Maximum Ratings (Ta = 25°C)

Characteris	stics	Symbol	Rating	Unit	
Drain-source voltage		V <sub>DSS</sub>	1000	V	
Drain-gate voltage (R <sub>GS</sub> = 20 kΩ)		$V_{DGR}$	1000	V	
Gate-source voltage		$V_{GSS}$	±30	V	
Drain current	DC (Note 1)	I <sub>D</sub>	12	Α	
	Pulse (Note 1)	I <sub>DP</sub>	36	A	
Drain power dissipation (Tc = 25°C)		$P_{D}$	200	W	
Channel temperature		T <sub>ch</sub>	150	°C	
Storage temperature range		T <sub>stg</sub>	-55~150	°C	

#### **Thermal Characteristics**

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	R <sub>th (ch-c)</sub>	0.625	°C/W
Thermal resistance, channel to ambient	R <sub>th (ch-a)</sub>	35.7	°C/W



Weight: 9.75 g (typ.)

Note 1: Please use devices on condition that the channel temperature is below 150°C.

This transistor is an electrostatic sensitive device.

Please handle with caution.

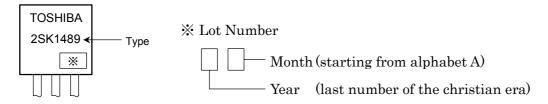
# **Electrical Characteristics (Ta = 25°C)**

Charac	teristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cu	rrent	I <sub>GSS</sub>	V <sub>GS</sub> = ±25 V, V <sub>DS</sub> = 0 V	_	_	±100	nA
Drain cut-off cur	rent	I <sub>DSS</sub>	V <sub>DS</sub> = 800 V, V <sub>GS</sub> = 0 V	_	_	300	μΑ
Drain-source br	eakdown voltage	V (BR) DSS	I <sub>D</sub> = 10 mA, V <sub>GS</sub> = 0 V	1000	_	_	V
Gate threshold v	roltage	V <sub>th</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1 mA	1.5	_	3.5	V
Drain-source Ol	N resistance	R <sub>DS (ON)</sub>	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 6 A	_	0.8	1.0	Ω
Forward transfer	admittance	Y <sub>fs</sub>	V <sub>DS</sub> = 20 V, I <sub>D</sub> = 6 A	4.0	6.0	_	S
Input capacitano	е	C <sub>iss</sub>	V <sub>DS</sub> = 25 V, V <sub>GS</sub> = 0 V, f = 1 MHz		2000	_	pF
Reverse transfer	capacitance	C <sub>rss</sub>			220	_	
Output capacitar	nce	Coss			360		
Switching time Fall	Rise time	t <sub>r</sub>	$V_{GS}$ $V_{OV}$ $V_{OUT}$ $V_{DD}$ $V_{DD}$	_	100	_	- ns
	Turn-on time	t <sub>on</sub>		_	140	_	
	Fall time	t <sub>f</sub>		_	150	_	
	Turn-off time	t <sub>off</sub>	Duty $\leq 1\%$ , $t_{\mathbf{W}} = 10 \mu \text{s}$	_	500	_	
Total gate charg plus gate–drain)		Qg			110	ı	
Gate-source charge		Q <sub>gs</sub>	$V_{DD} \approx 400 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 12 \text{ A}$		50	_	nC -
Gate-drain ("mil	cate-drain ("miller") charge Q <sub>gd</sub>		_	60	_		

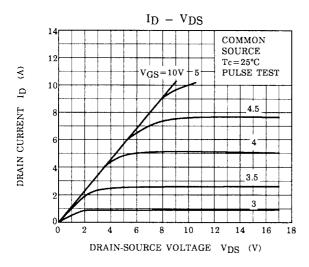
# **Source-Drain Ratings and Characteristics (Ta = 25°C)**

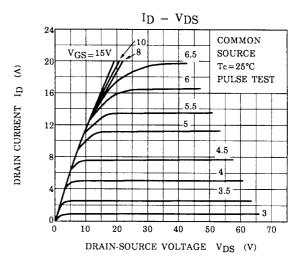
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I <sub>DR</sub>	_	_	_	12	Α
Pulse drain reverse current (Note 1)	I <sub>DRP</sub>	-	_	_	36	Α
Forward voltage (diode)	V <sub>DSF</sub>	I <sub>DR</sub> = 12 A, V <sub>GS</sub> = 0 V		_	-1.6	V

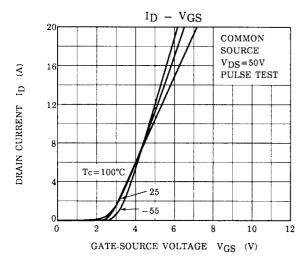
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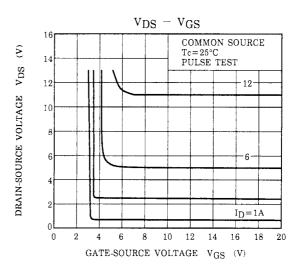


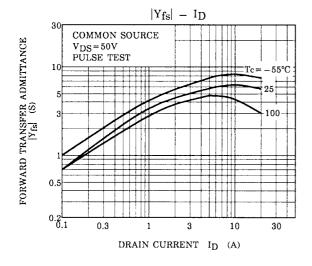
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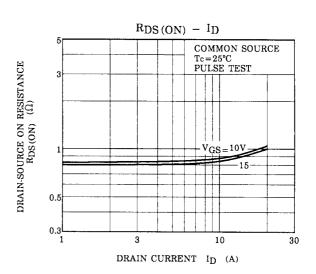




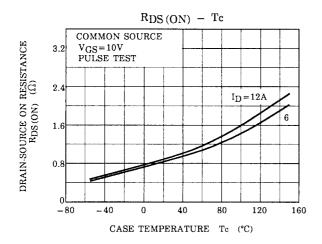


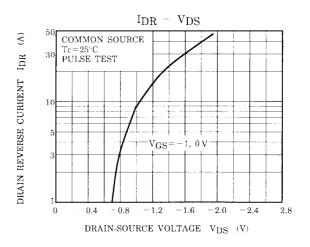


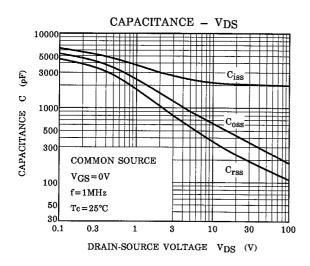


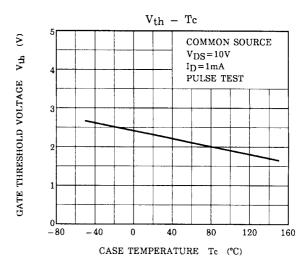


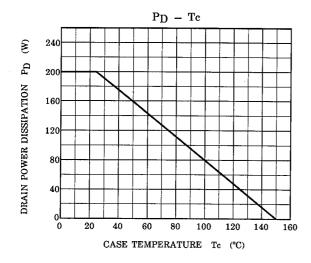
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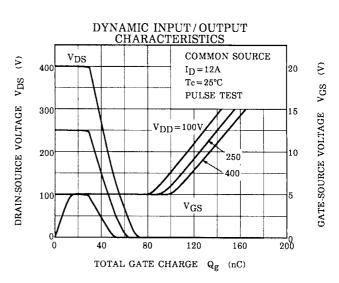




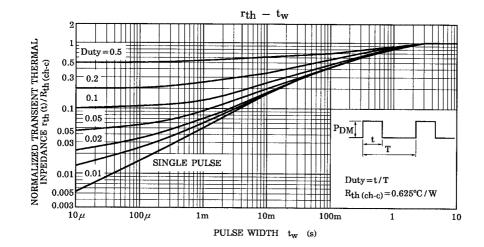


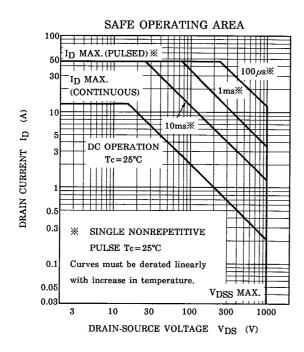






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